

ABS1 THRU ABS10

0.8A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

FEATURES:

• Glass Passivated Chip Juntion

• Reverse Voltage - 100 to 1000 V

• Forward Current - 0.8 A

• High Surge Current Capability

• Designed for Surface Mount Application

MECHANICAL DATA

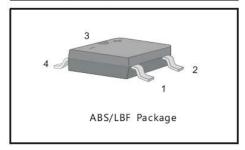
• Case: ABS/LBF

• Terminals: Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 88mg 0.0029oz

PINNING

PIN	DESCRIPTION	DESCRIPTION				
1	Input Pin (~)					
2	Input Pin (~)					
3	Output Anode (+)	tput Anode (+)				
4	Output Cathode (-)					



Maximum Ratings and Electrical characteristics

Ratings at 25° C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	ABS1	ABS2	ABS4	ABS6	ABS8	ABS10	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	200	400	600	800	1000	٧
Maximum RMS voltage	V _{RMS}	70	140	280	420	560	700	٧
Maximum DC Blocking Voltage	V _{DC}	100	200	400	600	800	1000	٧
Average Rectified Output Current at Ta = 40 °C	Io	0.8						А
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	30						А
Forward Voltage per element @I _F =0.4A @I _F =0.8A	V _F			1. 1.	-			٧
Maximum DC Reverse Current at Rated DC Blocking Voltage @T _a =25 °C @T _a =100°C @T _a =125 °C	I _R			1	.0 00 00			μА
Typical Junction Capacitance (Note1)	Cj			1	3			pF
Typical Thermal Resistance (Note2)	R _{eja} R _{ejl}			_	80 16		°C/W	
Operating and Storage Temperature Range	T_j , T_{stg}			-55 ~	+150			°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 1.3mm2 copper pad.



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Fig.1 Average Rectified Output Current Derating Curve

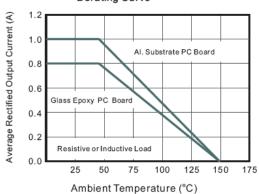


Fig.2 Typical Reverse Characteristics

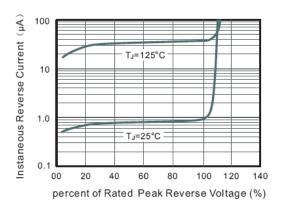


Fig.3 Typical Instaneous Forward Characteristics

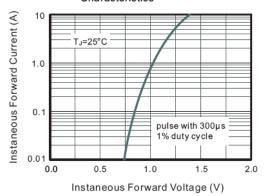


Fig.4 Typical Junction Capacitance

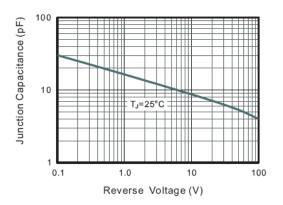
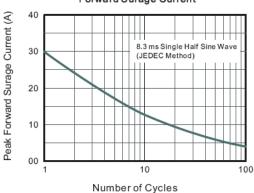


Fig. 5 Maximum Non-Repetitive Peak Forward Surage Current



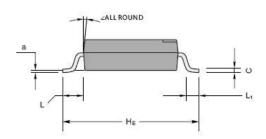
REV.08 2 of 3



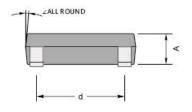
ABS1 THRU ABS10

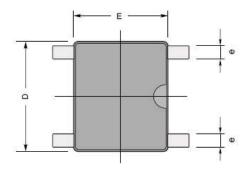
PACKAGE OUTLINE

Plastic surface mounted package; 4 leads



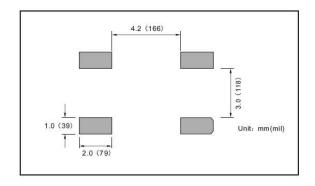






UNIT		Α	С	D	E	Η _ε	d	е	L	L ₁	а	_	
mm	max	1.5	0.22	5.2	4.5	6.4	4.2	0.7	0.95	0.6	0.2		
	min	1.3	0.15	4.9	4.2	6.0	3.8	0.5		0.93	0.0	0.0	0.2
mil	max	59	8.7	205	177	252	165	28	27	24	4	,	
mil	min	51	5.9	193	166	236	150	20	37	24	4		

The recommended mounting pad size



Marking

Type number	Marking code			
ABS1	ABS1			
ABS2	ABS2			
ABS4	ABS4			
ABS6	ABS6			
ABS8	ABS8			
ABS10	ABS10			
Al	BSxx			

REV.08 3 of 3

单击下面可查看定价,库存,交付和生命周期等信息

>>SHIKUES(时科)